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SP3485E

Product specification

DESCRIPTION

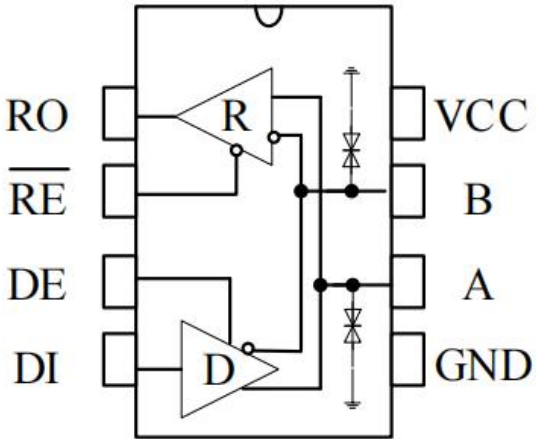

SP3485E is a RS-485 transceiver with 3.0V~5.5V wide power supply, bus port ESD protection capacity of over 15kV HBM, bus withstand voltage range of $\pm 15V$, half duplex, low power consumption, and fully meet the requirements of TIA / EIA-485 standard.

SP3485E includes a driver and a receiver, both of which can be enabled and closed independently. When both are disabled, both the driver and the receiver output are high resistance state. SP3485E has 1/8 load, which allows 256 SP3485E transceivers to be connected to the same communication bus. It can realize error-free data transmission up to 12Mbps.

FEATURES

- 3.0V~5.5V Wide Power Range, Half-Duplex
- ESD Protection for RS-485 I/O Pins $\pm 15kV$, Human Body Model
- Bus Fault Tolerance and Withstand Voltage Reach $\pm 15V$
- 1/8 Unit Load , Allow Up to 256 Transceivers on the Bus
- Driver Short-Circuit Output Protection
- Low Power Off Function
- Receiver Open-Circuit Failure Protection
- Strong Anti-Noise Ability
- Integrated Transient Voltage Suppression Function
- Data transmission up to 12Mbps in an electric noise environment

Reference News

| PIN CONFIGURATION | Marking |
|---|--|
|  |  |

PINNING

| PIN | SYMBOL | DESCRIPTION |
|------------|---------------|---|
| 1 | RO | Receiver Output. When /RE is low and if A - B \geq - 10mV, RO will be high; if A - B \leq -200mV, RO will be low. |
| 2 | /RE | Receiver Output Enable. Drive /RE low to enable RO; RO is high impedance when /RE is high. Drive /RE high and DE low to enter low-power shutdown mode. |
| 3 | DE | Driver Output Enable. Drive DE high to enable driver outputs. These outputs are high impedance when DE is low. Drive /RE high and DE low to enter low-power shutdown mode. |
| 4 | DI | Driver Input. With DE high, a low on DI forces non-inverting output low and inverting output high. Similarly, a high on DI forces non-inverting output high and inverting output low. |
| 5 | GND | Ground |
| 6 | A | non-inverting Receiver Input and non-inverting Driver Output |
| 7 | B | Inverting Receiver Input and Inverting Driver Output |
| 8 | VCC | Positive Supply |

LIMITING VALUES

| PARAMETER | SYMBOL | VALUE | UNIT |
|------------------------------|---------------|--------------|------|
| Supply voltage | VCC | +7 | V |
| Control Input Voltage | /RE , DE , DI | -0.3~VCC+0.5 | V |
| Receiver Input Voltage | A , B | -15~+15 | V |
| Receiver Output Voltage | RO | -0.3~VCC+0.5 | V |
| Operating Temperature Ranges | | -40~125 | °C |
| Storage Temperature Range | | -60~150 | °C |
| Lead Temperature | | 300 | °C |
| Continuous Power Dissipation | SOP8 | 470 | mW |
| | MSOP8 | 830 | mW |
| | DIP8 | 700 | mW |

The maximum limit parameters means that exceeding these values may cause irreversible damage to the device. Under these conditions, it is not conducive to the normal operation of the device. The continuous operation of the device at the maximum allowable rating may affect the reliability of the device. The reference point for all voltages is ground.

DRIVER DC ELECTRICAL CHARACTERISTICS

| PARAMETER | SYMBOL | CONDITION | MIN. | TYP. | MAX. | UNIT |
|---|-----------------|---|------|------|------|---------|
| Differential Driver Output (No load) | V_{OD1} | | 3 | | 5.5 | V |
| Differential Driver Output | V_{OD2} | Figure 2 , $R_L = 54 \Omega$, $V_{CC}=3.3V$ | 1.5 | | VCC | V |
| | | Figure 2 , $R_L = 54 \Omega$, $V_{CC}=5V$ | 1.5 | | VCC | V |
| Change in Magnitude of Driver Differential Output Voltage (NOTE1) | ΔV_{OD} | Figure 2 , $R_L = 54 \Omega$ | | | 0.2 | V |
| Driver Common-Mode Output Voltage | V_{OC} | Figure 2 , $R_L = 54 \Omega$ | | | 3 | V |
| Change in Magnitude of Common-Mode Output Voltage (NOTE1) | ΔV_{OC} | Figure 2 , $R_L = 54 \Omega$ | | | 0.2 | V |
| Input High Voltage | V_{IH} | DE , DI , /RE | 2.0 | | | V |
| Input Low Voltage | V_{IL} | DE , DI , /RE | | | 0.8 | V |
| Logic Input Current | I_{IN1} | DE , DI , /RE | -2 | | 2 | μA |
| Output short-circuit current, short-circuit to high | I_{OSD1} | short-circuit to 0V~12V | | | 250 | mA |
| Output short-circuit current, short-circuit to low | I_{OSD2} | short-circuit to -7V~0V | -250 | | | mA |

(Unless otherwise noted , Temp= T_{MIN} ~ T_{MAX} , Temp=25C)

NOTE1 : ΔV_{OD} and ΔV_{OC} are the changes in V_{OD} and V_{OC} , respectively, when the DI input changes state.

RECEIVER DC ELECTRICAL CHARACTERISTICS

| PARAMETER | SYMBOL | CONDITION | MIN. | TYP. | MAX. | UNIT |
|-----------------------|-----------|--|------|------|------|---------|
| Input current (A , B) | I_{IN2} | DE = 0 V , $V_{CC}=0$ 或 3.3/5V $V_{IN} = 12 V$ | | | 125 | μA |
| | | DE = 0 V , $V_{CC}=0$ 或 3.3/5V $V_{IN} = -7 V$ | -100 | | | μA |

| | | | | | | |
|--|-----------|--------------------------------------|----------------|----|----------|------------|
| Positive input threshold voltage | V_{IT+} | $-7V \leq V_{CM} \leq 12V$ | | | -10 | mV |
| Reverse input threshold voltage | V_{IT-} | $-7V \leq V_{CM} \leq 12V$ | -200 | | | mV |
| Input hysteresis voltage | V_{hys} | $-7V \leq V_{CM} \leq 12V$ | 10 | 30 | | mV |
| Receiver Output High Voltage | V_{OH} | $I_{OUT} = -2.5mA, V_{ID} = +200 mV$ | $V_{CC} - 1.5$ | | | V |
| Receiver Output Low Voltage | V_{OL} | $I_{OUT} = +2.5mA, V_{ID} = -200 mV$ | | | 0.4 | V |
| Three-State Output Current at Receiver | I_{OZR} | $0.4 V < V_O < 2.4 V$ | | | ± 1 | μA |
| Receiver Input Resistance | R_{IN} | $-7V \leq V_{CM} \leq 12V$ | 96 | | | k Ω |
| Receiver Short-Circuit Output Current | I_{OSR} | $0 V \leq V_O \leq V_{CC}$ | ± 8 | | ± 90 | mA |

(Unless otherwise noted , Temp= $T_{MIN} \sim T_{MAX}$, Temp=25C)

SUPPLY CURRENT

| PARAMETER | SYMBOL | CONDITION | MIN. | TYP. | MAX. | UNIT | |
|------------------|------------|----------------------------------|------|------|------|---------|---------|
| Supply Current | I_{CC1} | /RE=0V, DE = 0 V, VCC=3.3V | | 240 | 650 | μA | |
| | | /RE=0V, DE = 0 V VCC=5V | | 270 | 750 | μA | |
| | I_{CC2} | /RE=VCC, DE=VCC, VCC=3.3V | | | 250 | 650 | μA |
| | | /RE=VCC, DE=VCC, VCC=5V | | | 280 | 750 | μA |
| Shutdown current | I_{SHDN} | /RE=VCC, DE=0V, VCC=3.3V | | 0.2 | 10 | μA | |
| | | /RE=VCC, DE=0V, VCC=5V | | 0.2 | 10 | μA | |

DRIVER SWITCHING CHARACTERISTICS

| PARAMETER | SYMBOL | CONDITION | MIN. | TYP. | MAX. | UNIT |
|--|-----------|---|------|------|------|------|
| Driver differential Output delay | t_{DD} | $R_L = 60 \Omega$, $C_{L1}=C_{L2}=100pF$ (figure3 , 4) | | 20 | 40 | ns |
| Driver differential output Transition time | t_{TD} | | | 12 | 28 | ns |
| Drive propagation delay From low to high | t_{PLH} | $R_L = 27 \Omega$, (figure3 , 4) | | 20 | 40 | ns |
| Drive propagation delay From high to low | t_{PHL} | | | 20 | 40 | ns |
| $ t_{PLH}-t_{PHL} $ | t_{PDS} | | | 1 | 8 | ns |
| Driver Enable to Output High | t_{PZH} | $R_L = 110\Omega$, (figure5 , 6) | | | 55 | ns |
| Driver Enable to Output low | t_{PZL} | | | | 55 | ns |
| Driver Disable Time from Low | t_{PLZ} | $R_L = 110\Omega$, (figure 5 , 6) | | | 85 | ns |
| Driver Disable Time from high | t_{PHZ} | | | | 85 | ns |
| In Shutdown mode, Enable to Output High | t_{DSH} | $R_L = 110\Omega$, (figure 5 , 6) | | 20 | 100 | ns |
| In Shutdown mode , Enable to Output low | t_{DSL} | $R_L = 110\Omega$, (figure 5 , 6) | | 20 | 100 | ns |

RECEIVER SWITCHING CHARACTERISTICS

| PARAMETER | SYMBOL | CONDITION | MIN. | TYP. | MAX. | UNIT |
|---|------------|---------------------------------|------|------|------|------|
| Receiver Input to output from low to high | t_{RPLH} | $C_L=15pF$ Figure7 & Figure8 | | 60 | | ns |
| Receiver Input to output from high to low | t_{RPHL} | | | | 60 | ns |

| | | | | | | |
|---|-------------|---------------------------------|----|-----|-----|----|
| $ t_{RPLH} - t_{RPHL} $ | t_{RPDS} | | | 3 | 10 | ns |
| Receiver Enable to Output Low | t_{RPZL} | $C_L=15pF$ Figure7& Figure 8 | | 15 | 40 | ns |
| Receiver Enable to Output high | t_{RPZH} | $C_L=15pF$ Figure7 & Figure8 | | 15 | 40 | ns |
| Receiver Disable Time from Low | t_{PRLZ} | $C_L=15pF$ Figure7 & Figure8 | | 25 | 55 | ns |
| Receiver Disable Time from high | t_{PRHZ} | $C_L=15pF$ Figure7 & Figure8 | | 25 | 55 | ns |
| In Shutdown mode, Enable to Output High | t_{RPSH} | $C_L=15pF$ Figure7 & Figure8 | | 150 | 500 | ns |
| In Shutdown mode , Enable to Output low | $t_{RP SL}$ | $C_L=15pF$ Figure7 & Figure8 | | 150 | 500 | ns |
| Time to Shutdown | t_{SHDN} | NOTE2 | 50 | | 300 | ns |

NOTE2 : If the enable inputs are RE=high and DE=low for less than 50ns, the device is guaranteed not to enter shutdown. If the enable inputs are in this state for at least 300ns, the device is guaranteed to have entered shutdown.

FUNCTION TABLE

Driver Function

| CONTROL | | INPUT | OUTPUT | |
|--------------------------------|----|-------|-------------|---|
| /RE | DE | DI | A | B |
| X | 1 | 1 | H | L |
| X | 1 | 0 | L | H |
| 0 | 0 | X | Z | Z |
| 1 | 0 | X | Z(shutdown) | |
| X=irrelevant; Z=high impedance | | | | |

Receiver Function

| CONTROL | | INPUT | OUTPUT |
|--------------------------------|----|--------------------|--------|
| /RE | DE | A-B | RO |
| 0 | X | $\geq -10mV$ | H |
| 0 | X | $\leq -200mV$ | L |
| 0 | X | Open/short circuit | H |
| 1 | X | X | Z |
| X=irrelevant; Z=high impedance | | | |

TEST CIRCUIT

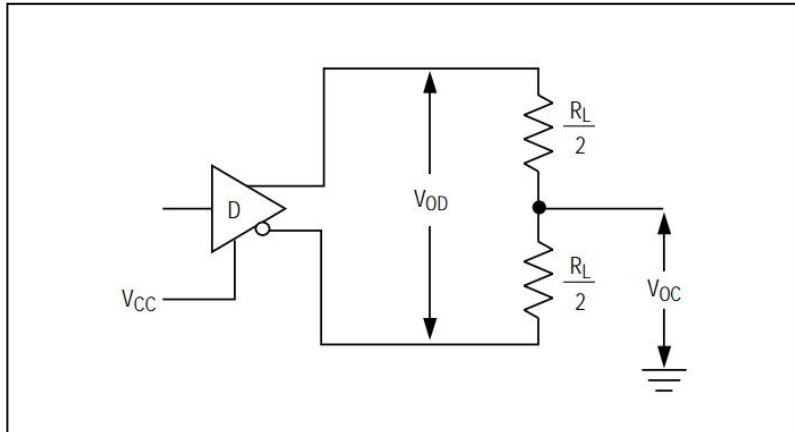
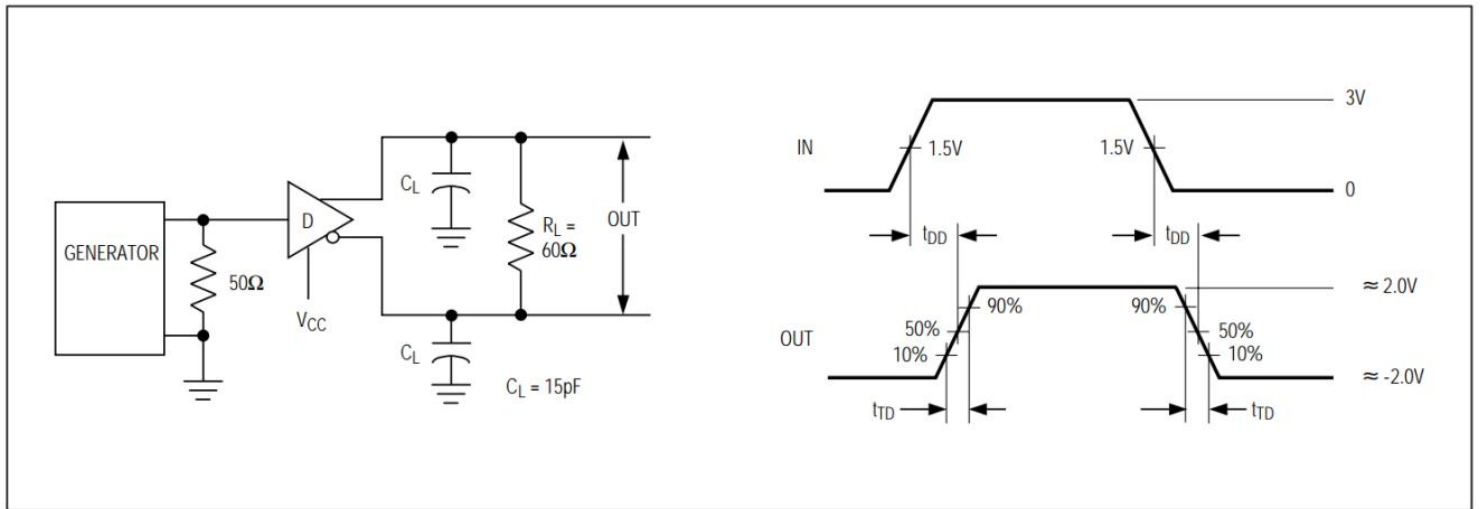


Figure 2 Driver DC test load



CL includes probe and stray capacitance (the same below)

Figure 3 Differential delay and transit time of driver

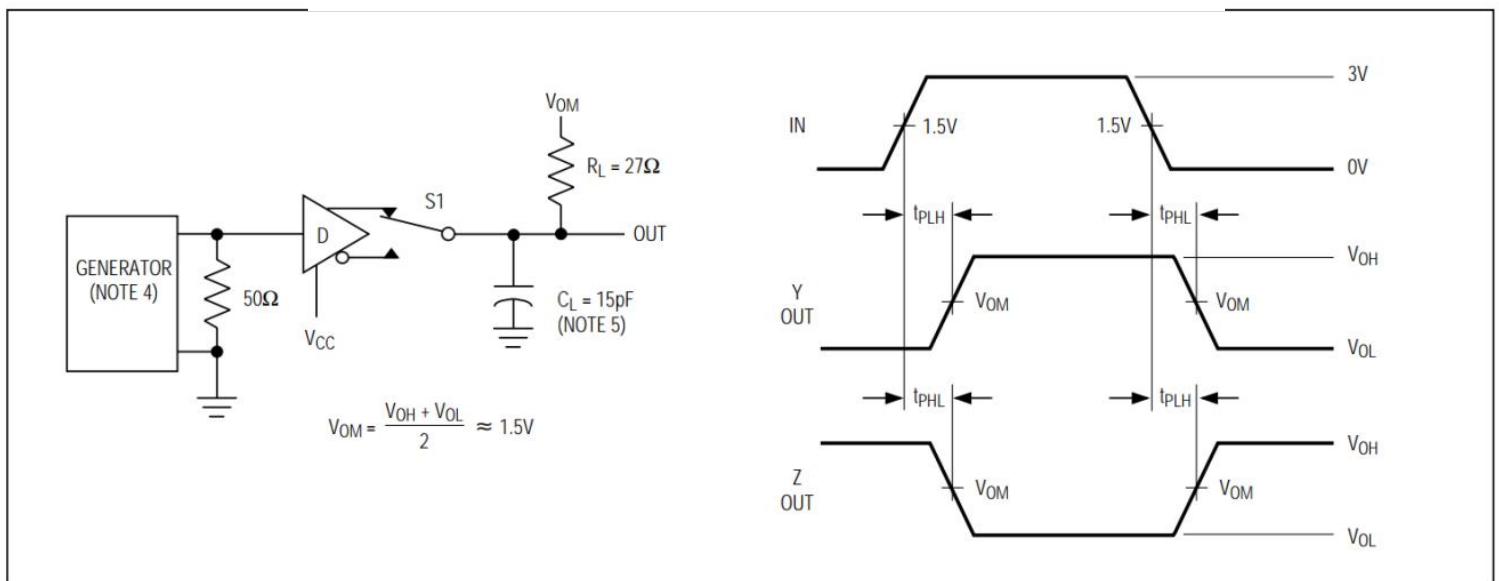


Figure 4 Drive propagation delay

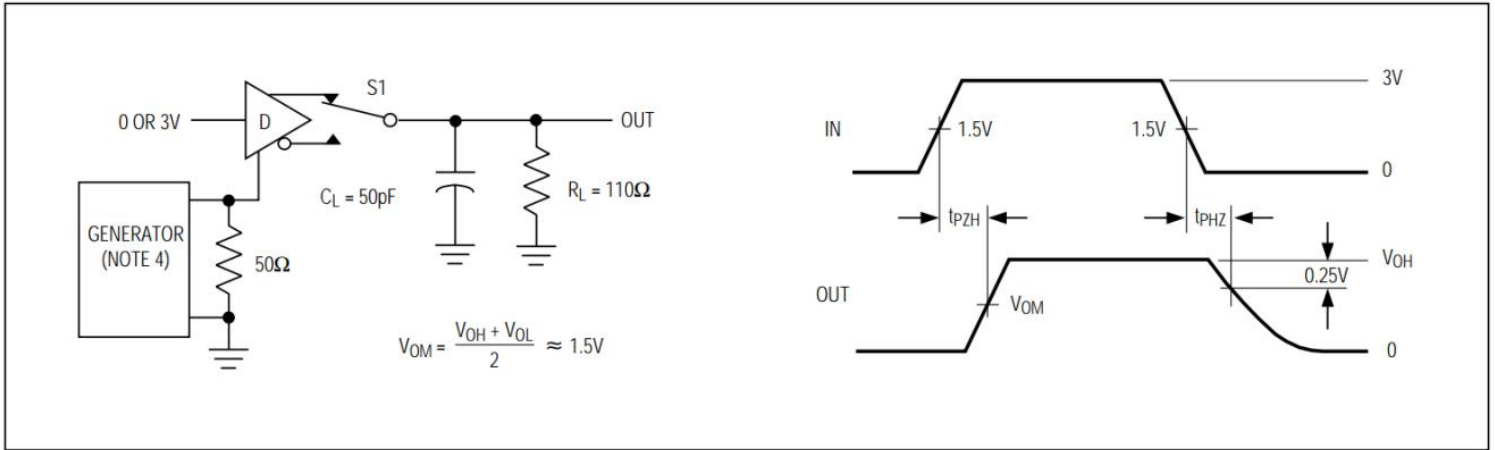


Figure 5 Drive enable and disable time

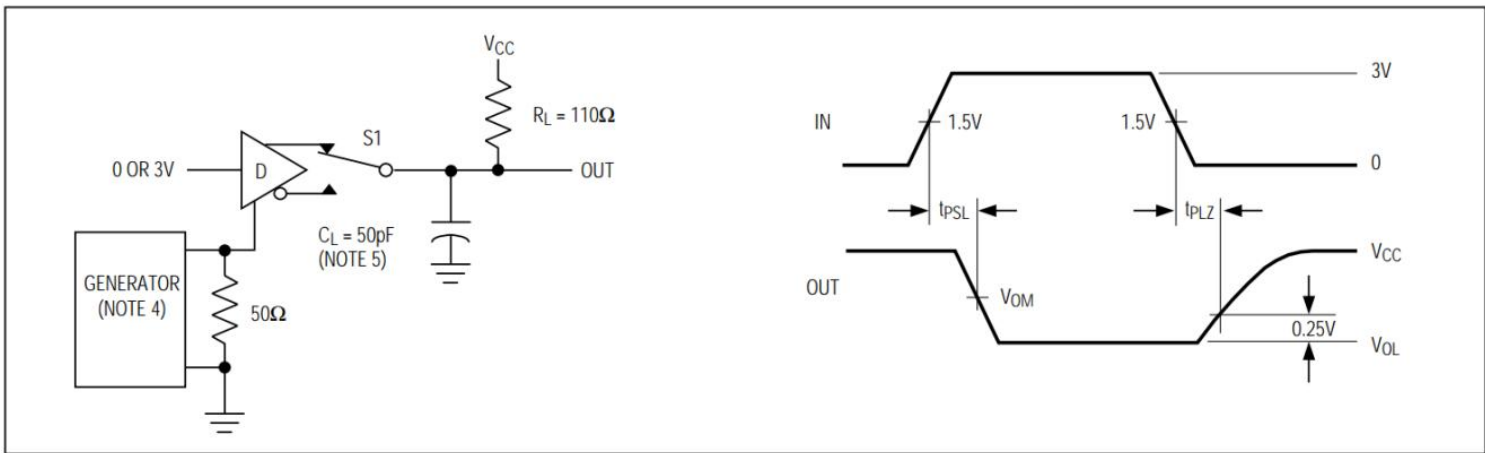


Figure 6 Drive enable and disable time

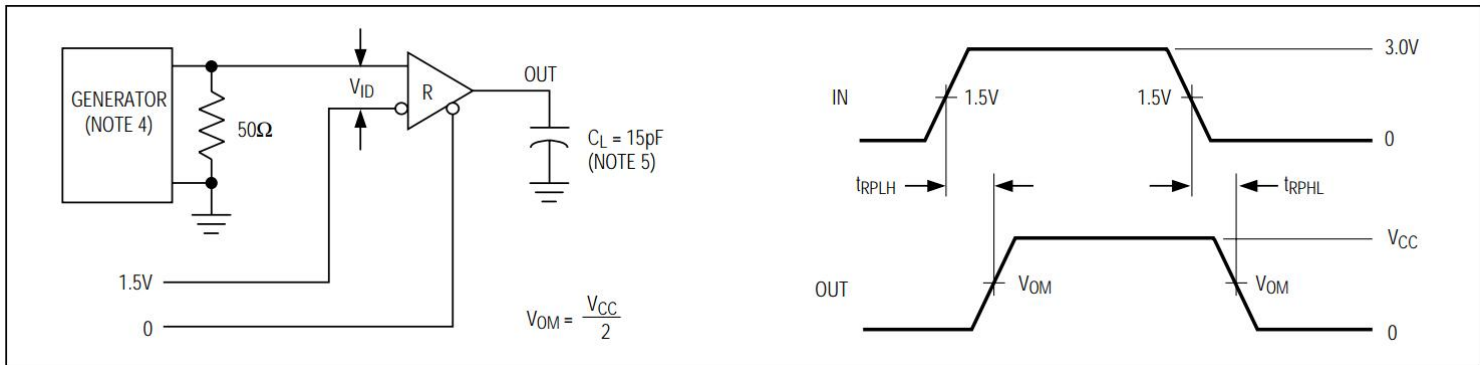


Figure 7 Receiver propagation delay test circuit

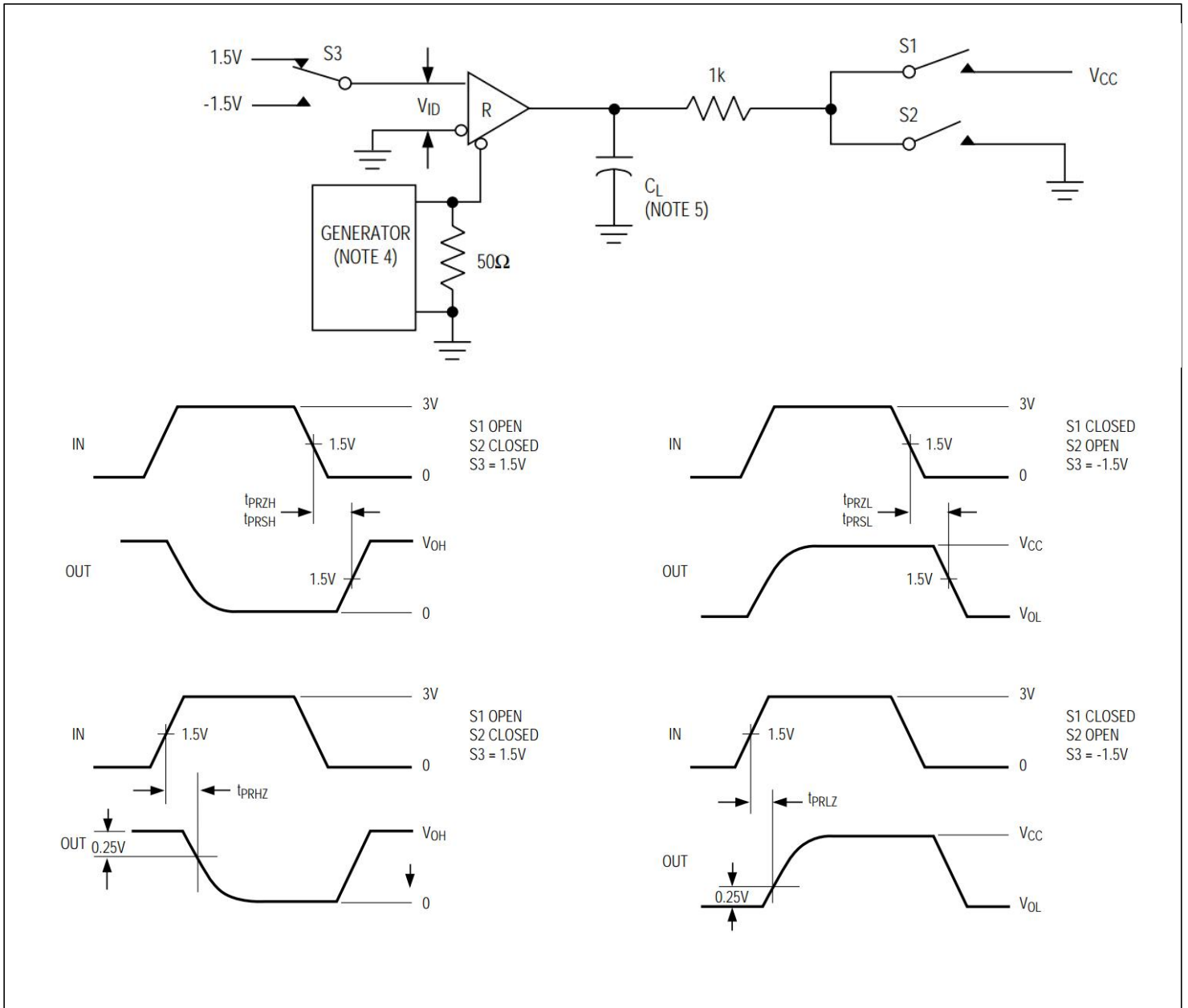


Figure 8 Receiver enable and disable time

ADDITIONAL DESCRIPTION

1 Sketch

SP3485E is a half-duplex high-speed transceiver with 3.0V~5.5V wide power supply, bus port ESD protection capacity of more than 15kV HBM, bus DC withstand voltage of more than $\pm 15V$, used for RS-485/RS-422 communication, including a driver and receiver. It has the functions of fail-safe, over-voltage protection, over-current protection and over temperature protection. SIT3485E realizes error-free data transmission up to 12Mbps.

2 Allowing up to 256 Transceivers on the Bus

The input impedance of the standard RS485 receiver is 12k Ω (1 unit load), and the standard driver can drive up to 32 unit loads. The receiver of SP3485E transceiver has 1/8 unit load input impedance (96k Ω), which allows up to 256 transceivers to be connected on the same communication bus in parallel. These devices can be combined arbitrarily or with other RS485 transceivers. Any combination of these devices and/or other RS-485 transceivers with a total of 32 unit loads or less can be connected to the line.

3 Driver output protection

Two mechanisms prevent excessive output current and power dissipation caused by faults or by bus contention. First, over-current protection, fast short circuit protection in the mode voltage range (refer to typical operating characteristics). Second, when the temperature of the tube core exceeds 140C, the output of the driver is forced into the high resistance state.

4 Typical Applications

4. 1Bus Networking: SP3485E RS485 transceiver is designed for bidirectional data communication on multi-point bus transmission line. Figure 9 shows a typical network application circuit. These devices can also be used as linear repeaters with cables longer than 4000 feet. In order to reduce reflection, terminal matching should be carried out at both ends of the transmission line with its characteristic impedance, and the length of branch lines outside the main line should be as short as possible

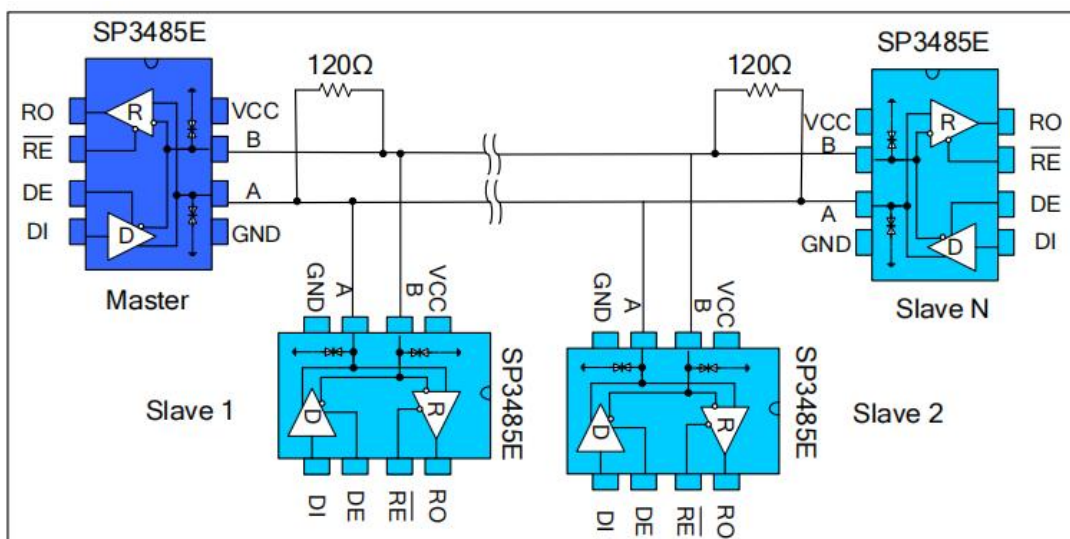


Figure 9 Bus type RS485 half duplex communication

4.2 Hand in hand Networking: also known as daisy chain topology, is the standard and specification of RS485 bus wiring, and is the RS485 bus topology recommended by TIA and other organizations. The wiring mode is that the main control equipment and a plurality of slave control equipment form a hand-held connection mode, as shown in Figure 10, and the hand-held mode is no branches. This wiring mode has the advantages of small signal reflection and high communication success rate.

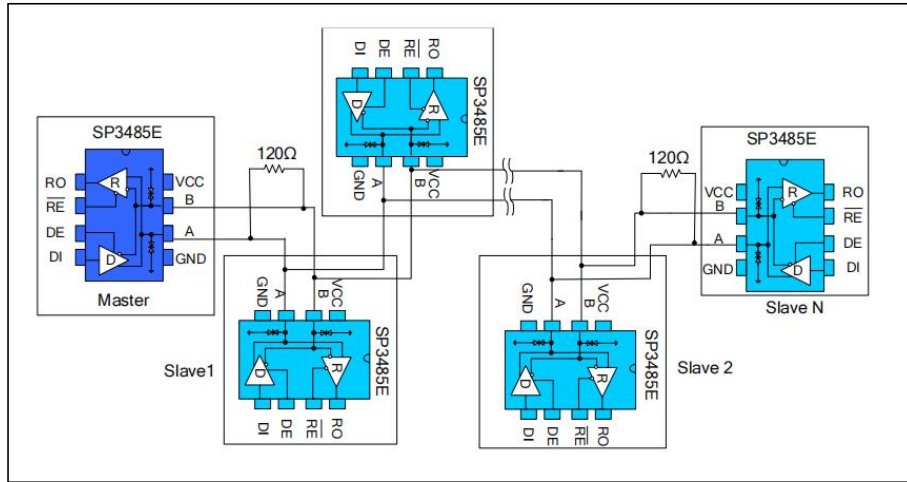
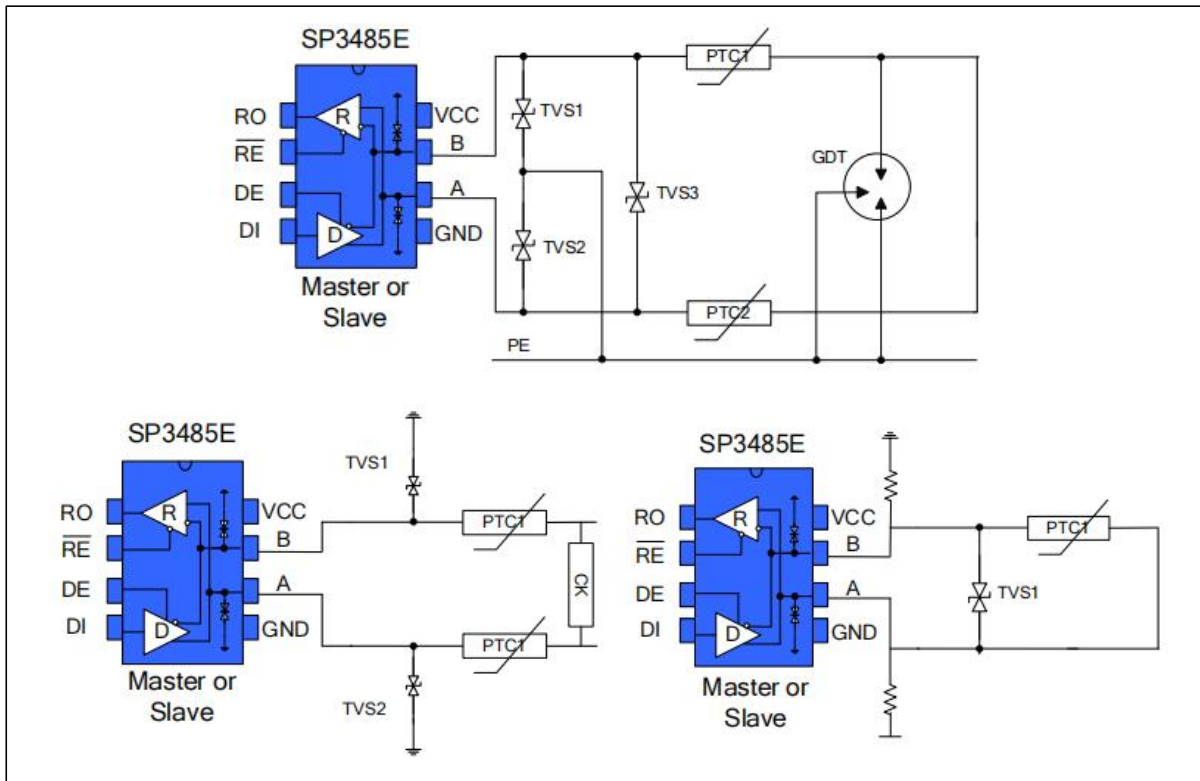


Figure10 Hand in hand RS485 half duplex communication network

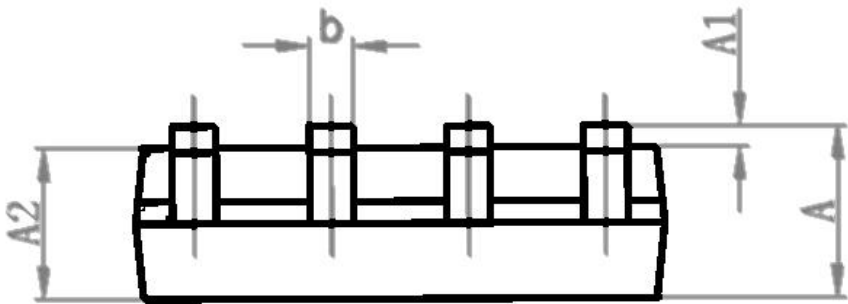
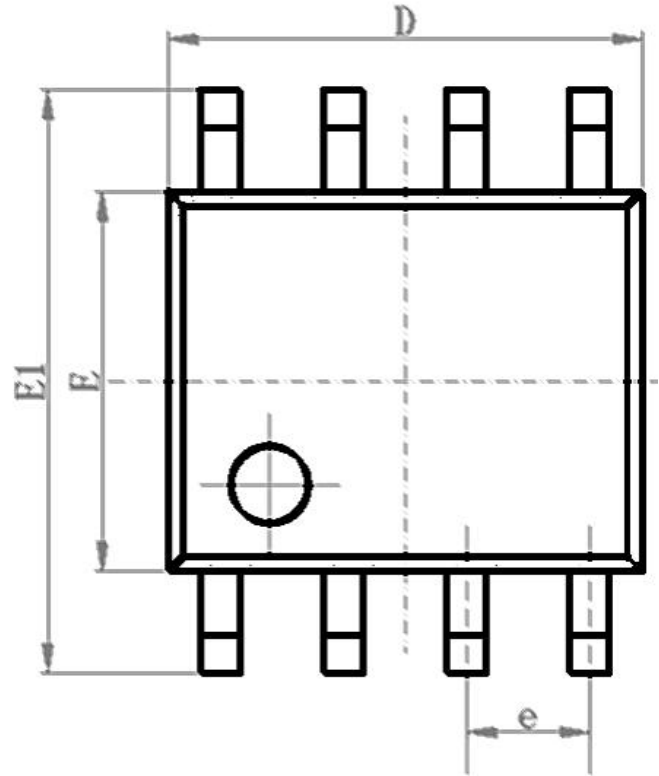
4.3 Bus port protection: in severe environment, RS485 communication port is usually provided with electrostatic protection, lightning surge protection and other additional protection, and even the plan to prevent 380V market electricity access is needed to avoid the damage of intelligent instrument and industrial control host. Figure 11 shows three common RS485 bus port protection schemes. The first is the scheme of three-level protection by connecting TVS devices in parallel with A,B port to the protective ground, TVS devices in parallel with A,B port, thermistor in series with A,B port, gas discharge tube in parallel to the protective ground; the second is the scheme of three-level protection by connecting TVS in parallel with A,B port to the ground, thermistor in series with A,B port, and varistor in parallel with A,B port; the third is the scheme of three-level protection by connecting AB with pull-up or pull-down resistor to power and ground respectively, connecting TVS between A & B, A or B port connecting thermistor.



SOP8 DIMENSIONS

PACKAGE SIZE

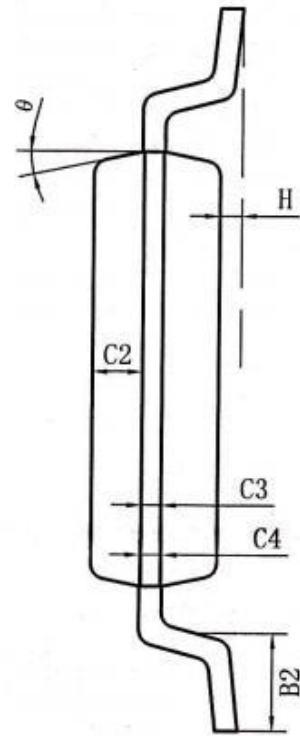
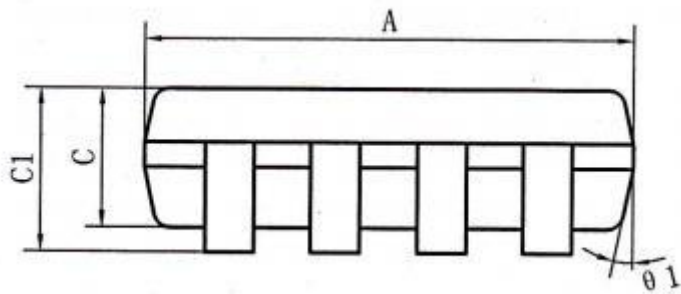
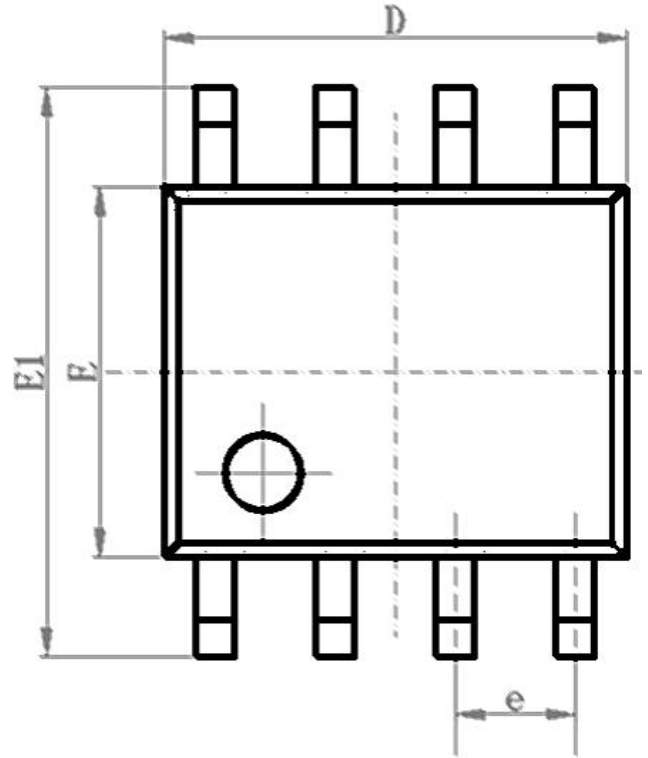
| SYMBOL | MIN./mm | TYP./mm | MAX./mm |
|----------|---------|---------|---------|
| A | 1.40 | - | 1.80 |
| A1 | 0.10 | - | 0.25 |
| A2 | 1.30 | 1.40 | 1.50 |
| b | 0.38 | - | 0.51 |
| D | 4.80 | 4.90 | 5.00 |
| E | 3.80 | 3.90 | 4.00 |
| E1 | 5.80 | 6.00 | 6.20 |
| e | | 1.27BSC | |
| L | 0.40 | 0.60 | 0.80 |
| c | 0.20 | - | 0.25 |
| θ | 0° | - | 8° |



MSOP8 /8μMAX / VSSOP8 DIMENSIONS

PACKAGE SIZE

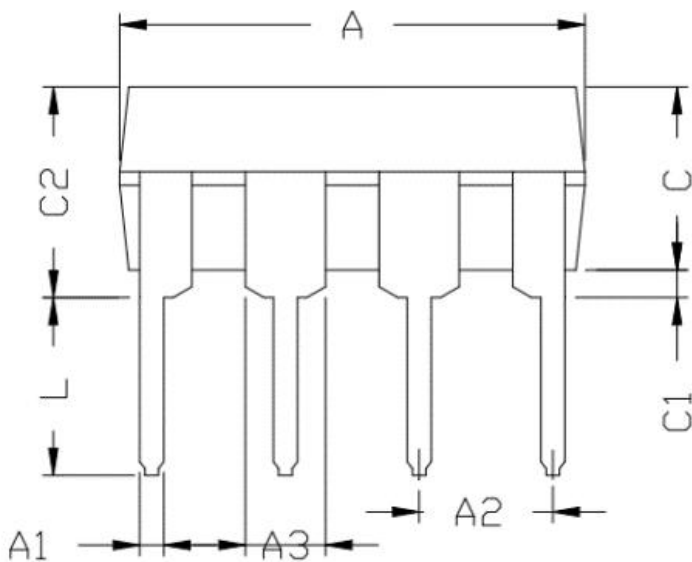
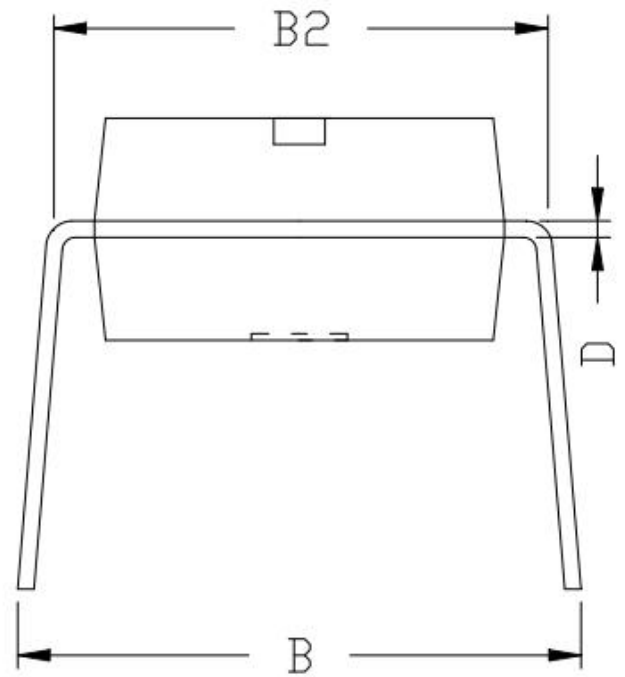
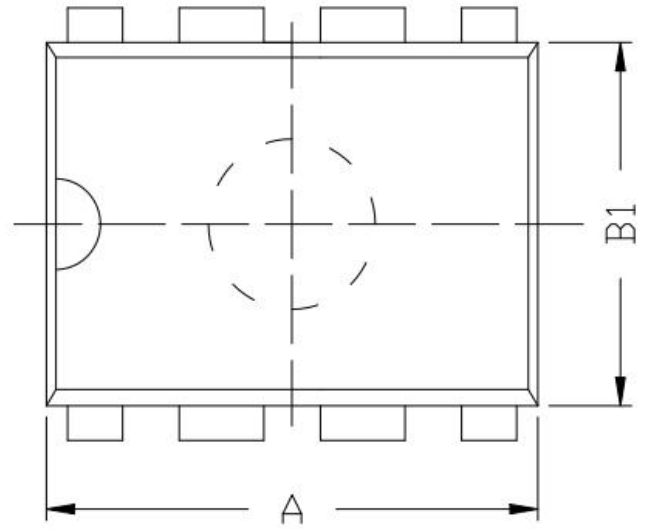
| SYMBOL | MIN./mm | TYP./mm | MAX./mm |
|--------|-----------|---------|---------|
| A | 2.90 | 3.0 | 3.10 |
| A1 | 0.28 | | 0.35 |
| A2 | 0.65TYP | | |
| A3 | 0.375TYP | | |
| B | 2.90 | 3.0 | 3.10 |
| B1 | 4.70 | | 5.10 |
| B2 | 0.45 | | 0.75 |
| C | 0.75 | | 0.95 |
| C1 | | | 1.10 |
| C2 | 0.328 TYP | | |
| C3 | 0.152 | | |
| C4 | 0.15 | | 0.23 |
| H | 0.00 | | 0.09 |
| θ | 12° TYP | | |



DIP8 DIMENSIONS

PACKAGE SIZE

| SYMBOL | MIN./mm | TYP./mm | MAX./mm |
|--------|----------|---------|---------|
| A | 9.00 | 9.20 | 9.40 |
| A1 | 0.33 | 0.45 | 0.51 |
| A2 | 2.54TYP | | |
| A3 | 1.525TYP | | |
| B | 8.40 | 8.70 | 9.10 |
| B1 | 6.20 | 6.40 | 6.60 |
| B2 | 7.32 | 7.62 | 7.92 |
| C | 3.20 | 3.40 | 3.60 |
| C1 | 0.50 | 0.60 | 0.80 |
| C2 | 3.71 | 4.00 | 4.31 |
| D | 0.20 | 0.28 | 0.36 |
| L | 3.00 | 3.30 | 3.60 |



ORDERING INFORMATION

| TYPE NUMBER | TEMPERATURE | PACKAGE |
|-------------|-------------|----------------------|
| SP3485EN-MS | -40C~125C | SOP8 |
| SP3485EU-MS | -40C~125C | MSOP8/VSSOP8/8 μ MAX |
| SP3485EP-MS | -40C~125C | DIP8 |

Tapered package is 2500 pcs/reel. The HVSON8/DFN3*3-8 package is 5000 pcs/reel.

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